



Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	12
Program Memory Size	768B (512 x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	25 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 6.25V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	18-SOIC (0.295", 7.50mm Width)
Supplier Device Package	18-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c54-xti-so

Table of Contents

1.0	General Description.....	5
2.0	PIC16C5X Device Varieties	7
3.0	Architectural Overview	9
4.0	Oscillator Configurations	15
5.0	Reset.....	19
6.0	Memory Organization	25
7.0	I/O Ports	35
8.0	Timer0 Module and TMR0 Register	37
9.0	Special Features of the CPU.....	43
10.0	Instruction Set Summary.....	49
11.0	Development Support.....	61
12.0	Electrical Characteristics - PIC16C54/55/56/57	67
13.0	Electrical Characteristics - PIC16CR54A	79
14.0	Device Characterization - PIC16C54/55/56/57/CR54A	91
15.0	Electrical Characteristics - PIC16C54A	103
16.0	Device Characterization - PIC16C54A	117
17.0	Electrical Characteristics - PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/C58B/CR58B	131
18.0	Device Characterization - PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/C58B/CR58B	145
19.0	Electrical Characteristics - PIC16C54C/C55A/C56A/C57C/C58B 40MHz	155
20.0	Device Characterization - PIC16C54C/C55A/C56A/C57C/C58B 40MHz	165
21.0	Packaging Information.....	171
	Appendix A: Compatibility	182
	On-Line Support.....	187
	Reader Response	188
	Product Identification System	189

TO OUR VALUED CUSTOMERS

It is our intention to provide our valued customers with the best documentation possible to ensure successful use of your Microchip products. To this end, we will continue to improve our publications to better suit your needs. Our publications will be refined and enhanced as new volumes and updates are introduced.

If you have any questions or comments regarding this publication, please contact the Marketing Communications Department via E-mail at docerrors@mail.microchip.com or fax the **Reader Response Form** in the back of this data sheet to (480) 792-4150. We welcome your feedback.

Most Current Data Sheet

To obtain the most up-to-date version of this data sheet, please register at our Worldwide Web site at:

<http://www.microchip.com>

You can determine the version of a data sheet by examining its literature number found on the bottom outside corner of any page. The last character of the literature number is the version number, (e.g., DS30000A is version A of document DS30000).

Errata

An errata sheet, describing minor operational differences from the data sheet and recommended workarounds, may exist for current devices. As device/documentation issues become known to us, we will publish an errata sheet. The errata will specify the revision of silicon and revision of document to which it applies.

To determine if an errata sheet exists for a particular device, please check with one of the following:

- Microchip's Worldwide Web site; <http://www.microchip.com>
- Your local Microchip sales office (see last page)
- The Microchip Corporate Literature Center; U.S. FAX: (480) 792-7277

When contacting a sales office or the literature center, please specify which device, revision of silicon and data sheet (include literature number) you are using.

Customer Notification System

Register on our web site at www.microchip.com/cn to receive the most current information on all of our products.

2.0 PIC16C5X DEVICE VARIETIES

A variety of frequency ranges and packaging options are available. Depending on application and production requirements, the proper device option can be selected using the information in this section. When placing orders, please use the PIC16C5X Product Identification System at the back of this data sheet to specify the correct part number.

For the PIC16C5X family of devices, there are four device types, as indicated in the device number:

1. **C**, as in PIC16**C**54C. These devices have EPROM program memory and operate over the standard voltage range.
2. **LC**, as in PIC16**LC**54A. These devices have EPROM program memory and operate over an extended voltage range.
3. **CR**, as in PIC16**CR**54A. These devices have ROM program memory and operate over the standard voltage range.
4. **LCR**, as in PIC16**LCR**54A. These devices have ROM program memory and operate over an extended voltage range.

2.1 UV Erasable Devices (EPROM)

The UV erasable versions offered in Cerdip packages, are optimal for prototype development and pilot programs.

UV erasable devices can be programmed for any of the four oscillator configurations. Microchip's PICSTART® Plus⁽¹⁾ and PRO MATE® programmers both support programming of the PIC16C5X. Third party programmers also are available. Refer to the Third Party Guide (DS00104) for a list of sources.

2.2 One-Time-Programmable (OTP) Devices

The availability of OTP devices is especially useful for customers expecting frequent code changes and updates, or small volume applications.

The OTP devices, packaged in plastic packages, permit the user to program them once. In addition to the program memory, the configuration bits must be programmed.

Note 1: PIC16LC54C and PIC16C54A devices require OSC2 not to be connected while programming with PICSTART® Plus programmer.

2.3 Quick-Turnaround-Production (QTP) Devices

Microchip offers a QTP Programming Service for factory production orders. This service is made available for users who choose not to program a medium to high quantity of units and whose code patterns have stabilized. The devices are identical to the OTP devices but with all EPROM locations and configuration bit options already programmed by the factory. Certain code and prototype verification procedures apply before production shipments are available. Please contact your Microchip Technology sales office for more details.

2.4 Serialized Quick-Turnaround-Production (SQTPSM) Devices

Microchip offers the unique programming service where a few user defined locations in each device are programmed with different serial numbers. The serial numbers may be random, pseudo-random or sequential. The devices are identical to the OTP devices but with all EPROM locations and configuration bit options already programmed by the factory.

Serial programming allows each device to have a unique number which can serve as an entry code, password or ID number.

2.5 Read Only Memory (ROM) Devices

Microchip offers masked ROM versions of several of the highest volume parts, giving the customer a low cost option for high volume, mature products.

7.6 I/O Programming Considerations

7.6.1 BI-DIRECTIONAL I/O PORTS

Some instructions operate internally as read followed by write operations. The BCF and BSF instructions, for example, read the entire port into the CPU, execute the bit operation and re-write the result. Caution must be used when these instructions are applied to a port where one or more pins are used as input/outputs. For example, a BSF operation on bit5 of PORTB will cause all eight bits of PORTB to be read into the CPU, bit5 to be set and the PORTB value to be written to the output latches. If another bit of PORTB is used as a bi-directional I/O pin (say bit0) and it is defined as an input at this time, the input signal present on the pin itself would be read into the CPU and rewritten to the data latch of this particular pin, overwriting the previous content. As long as the pin stays in the Input mode, no problem occurs. However, if bit0 is switched into Output mode later on, the content of the data latch may now be unknown.

Example 7-1 shows the effect of two sequential read-modify-write instructions (e.g., BCF, BSF, etc.) on an I/O port.

A pin actively outputting a high or a low should not be driven from external devices at the same time in order to change the level on this pin ("wired-or", "wired-and"). The resulting high output currents may damage the chip.

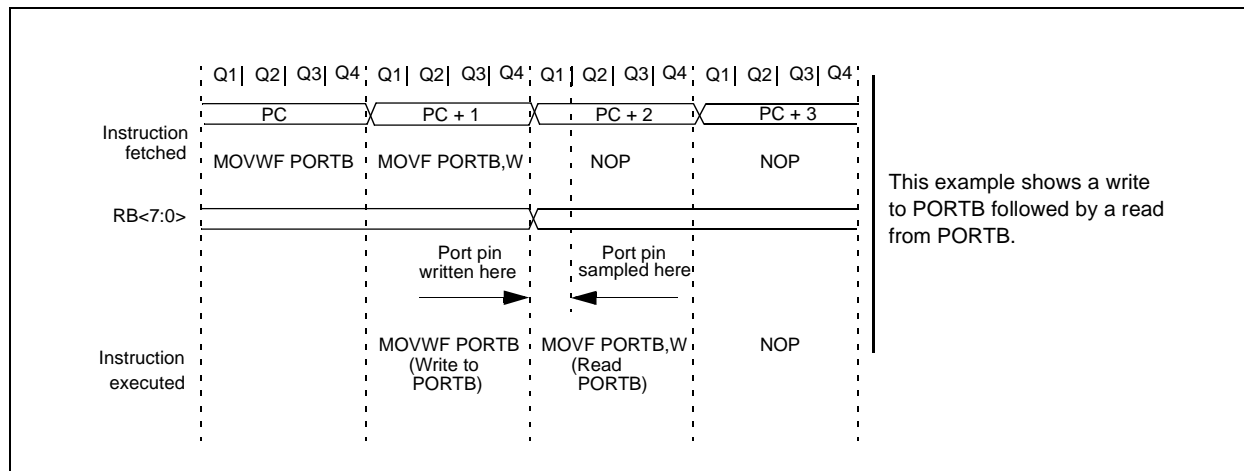
EXAMPLE 7-1: READ-MODIFY-WRITE INSTRUCTIONS ON AN I/O PORT

```
;Initial PORT Settings
; PORTB<7:4> Inputs
; PORTB<3:0> Outputs
;PORTB<7:6> have external pull-ups and are
;not connected to other circuitry
;
;                                PORT latch  PORT pins
;                                -----
BCF  PORTB, 7 ;01pp pppp  11pp pppp
BCF  PORTB, 6 ;10pp pppp  11pp pppp
MOVLW H'3F'   ;
TRIS  PORTB   ;10pp pppp  10pp pppp
;
;Note that the user may have expected the pin
;values to be 00pp pppp. The 2nd BCF caused
;RB7 to be latched as the pin value (High).
```

7.6.2 SUCCESSIVE OPERATIONS ON I/O PORTS

The actual write to an I/O port happens at the end of an instruction cycle, whereas for reading, the data must be valid at the beginning of the instruction cycle (Figure 7-2). Therefore, care must be exercised if a write followed by a read operation is carried out on the same I/O port. The sequence of instructions should allow the pin voltage to stabilize (load dependent) before the next instruction, which causes that file to be read into the CPU, is executed. Otherwise, the previous state of that pin may be read into the CPU rather than the new state. When in doubt, it is better to separate these instructions with a NOP or another instruction not accessing this I/O port.

FIGURE 7-2: SUCCESSIVE I/O OPERATION



PIC16C5X

FIGURE 8-3: TIMER0 TIMING: INTERNAL CLOCK/NO PRESCALER

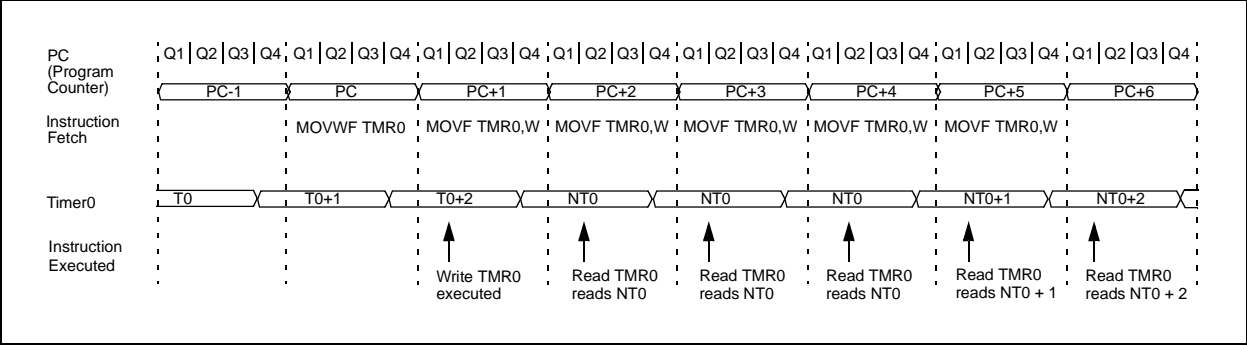


FIGURE 8-4: TIMER0 TIMING: INTERNAL CLOCK/PRESCALER 1:2

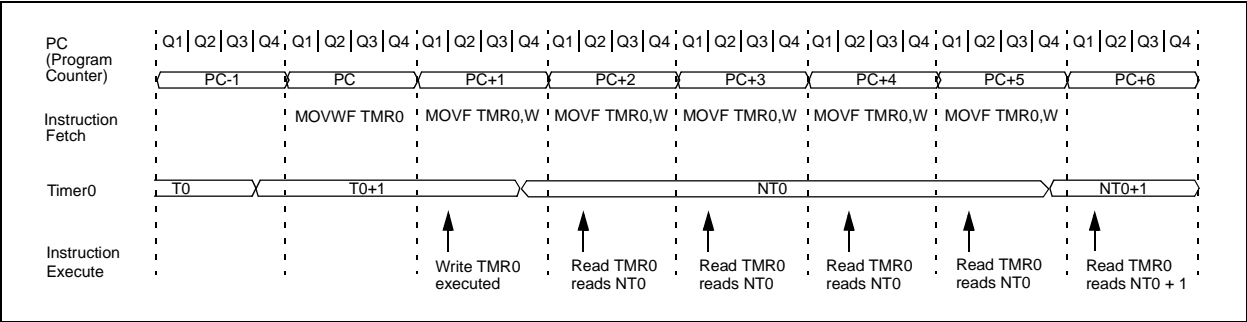


TABLE 8-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on MCLR and WDT Reset
01h	TMR0	Timer0 - 8-bit real-time clock/counter								xxxx xxxx	uuuu uuuu
N/A	OPTION	—	—	T0CS	T0SE	PSA	PS2	PS1	PS0	--11 1111	--11 1111

Legend: x = unknown, u = unchanged, - = unimplemented. Shaded cells not used by Timer0.

PIC16C5X

COMF Complement f

Syntax: [*label*] COMF f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) \rightarrow (dest)$

Status Affected: Z

Encoding:

0010	01df	ffff
------	------	------

Description: The contents of register 'f' are complemented. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example: COMF REG1, 0

Before Instruction

REG1 = 0x13

After Instruction

REG1 = 0x13

W = 0xEC

DECF Decrement f

Syntax: [*label*] DECF f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) - 1 \rightarrow (dest)$

Status Affected: Z

Encoding:

0000	11df	ffff
------	------	------

Description: Decrement register 'f'. If 'd' is 0 the result is stored in the W register. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example: DECF CNT, 1

Before Instruction

CNT = 0x01

Z = 0

After Instruction

CNT = 0x00

Z = 1

DECFSZ Decrement f, Skip if 0

Syntax: [*label*] DECFSZ f,d

Operands: $0 \leq f \leq 31$
 $d \in [0,1]$

Operation: $(f) - 1 \rightarrow d$; skip if result = 0

Status Affected: None

Encoding:

0010	11df	ffff
------	------	------

Description: The contents of register 'f' are decremented. If 'd' is 0 the result is placed in the W register. If 'd' is 1 the result is placed back in register 'f'.
 If the result is 0, the next instruction, which is already fetched, is discarded and a NOP is executed instead making it a two-cycle instruction.

Words: 1

Cycles: 1(2)

Example:

HERE	DECFSZ	CNT, 1
	GOTO	LOOP
CONTINUE	•	
	•	
	•	

Before Instruction

PC = address (HERE)

After Instruction

CNT = CNT - 1;

if CNT = 0,

PC = address (CONTINUE);

if CNT \neq 0,

PC = address (HERE+1)

FIGURE 14-2: TYPICAL RC OSC FREQUENCY vs. VDD, CEXT = 20 PF

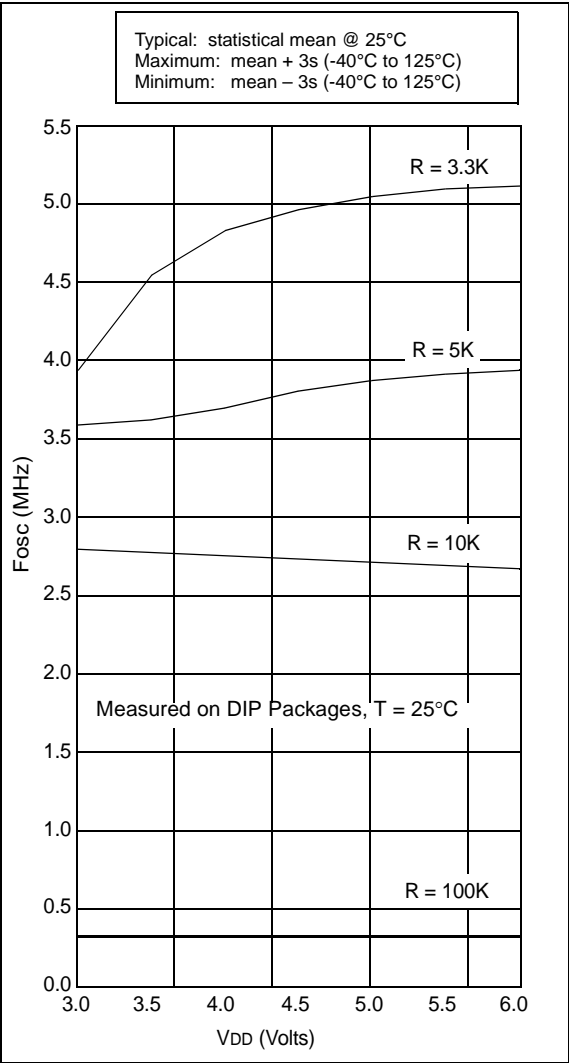


FIGURE 14-3: TYPICAL RC OSC FREQUENCY vs. VDD, CEXT = 100 PF

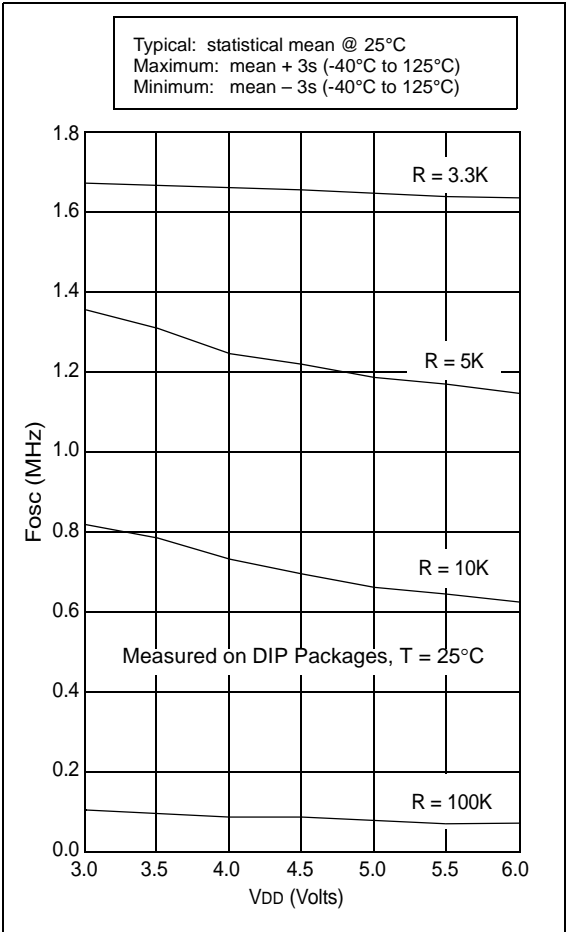


FIGURE 14-13: MAXIMUM IDD VS. FREQUENCY (EXTERNAL CLOCK, -40°C TO +85°C)

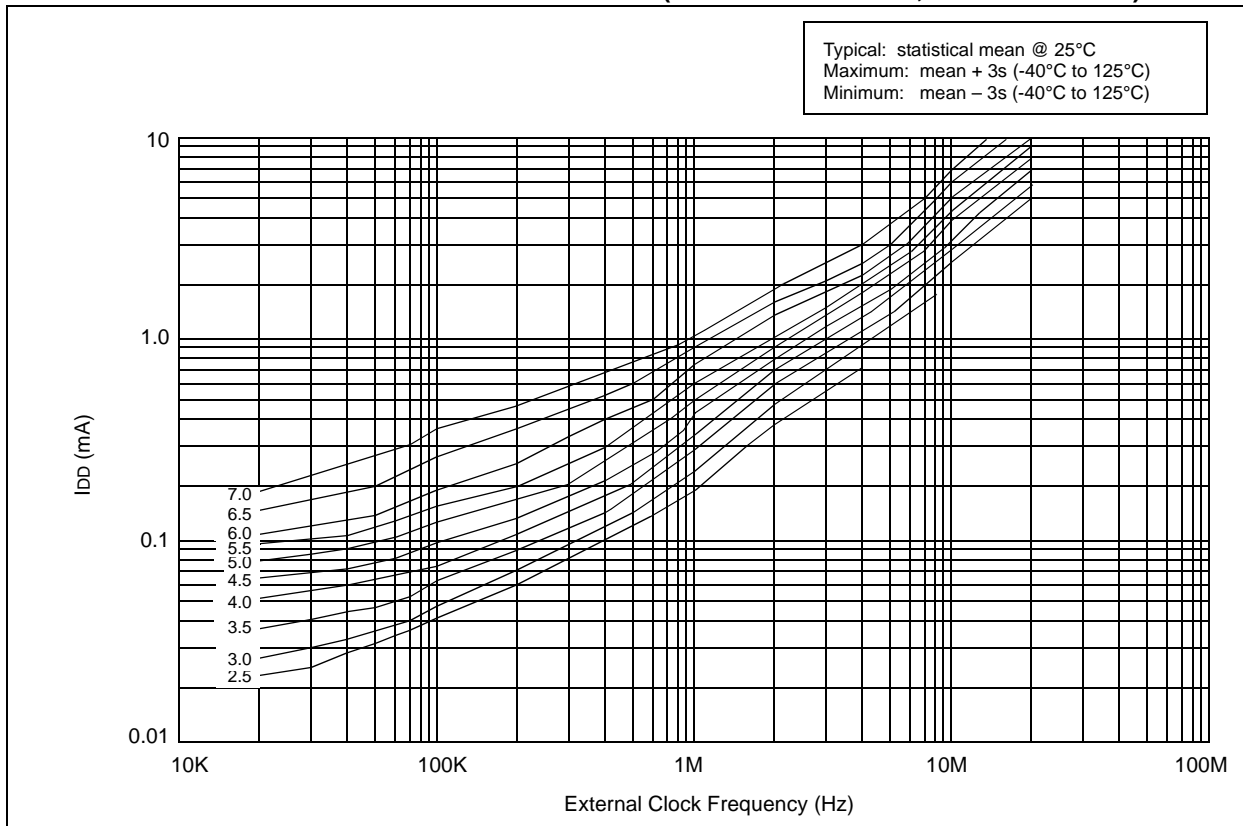


FIGURE 14-14: MAXIMUM I_{DD} vs. FREQUENCY (EXTERNAL CLOCK -55°C TO +125°C)

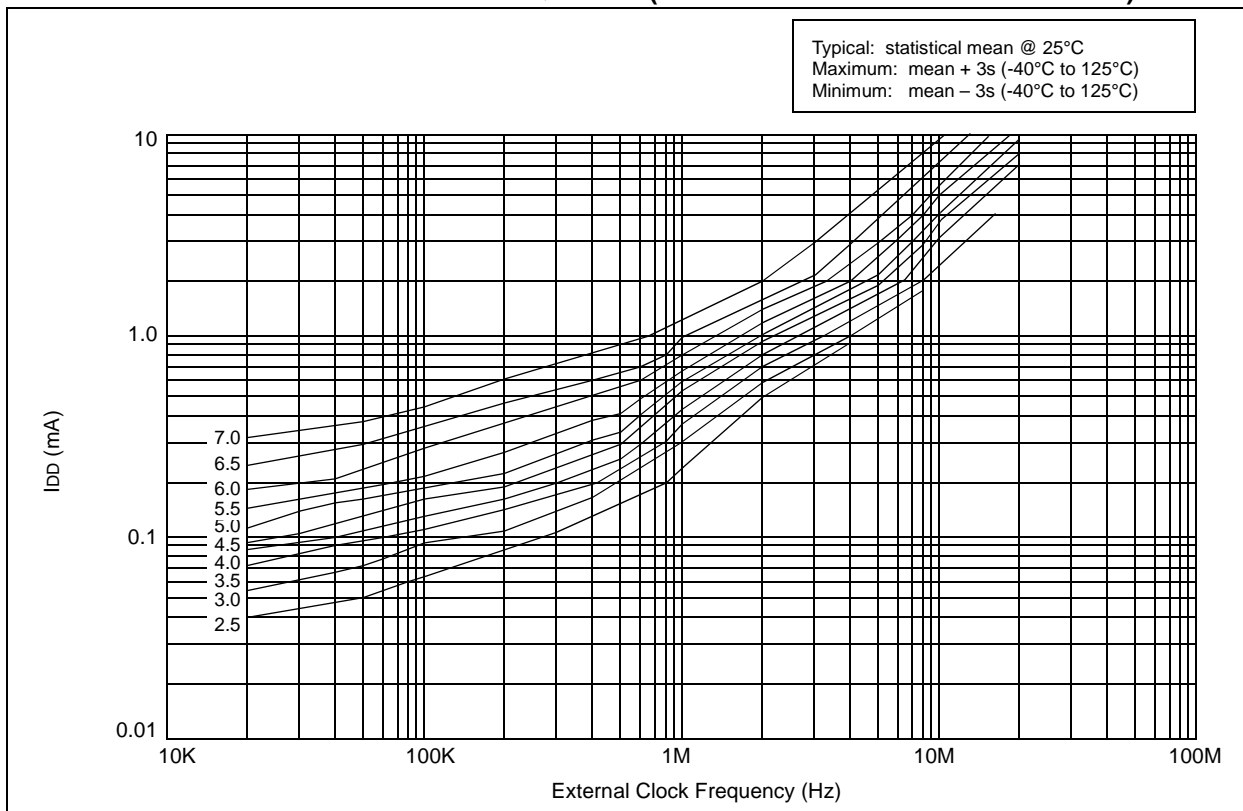


FIGURE 14-15: WDT TIMER TIME-OUT PERIOD vs. VDD⁽¹⁾

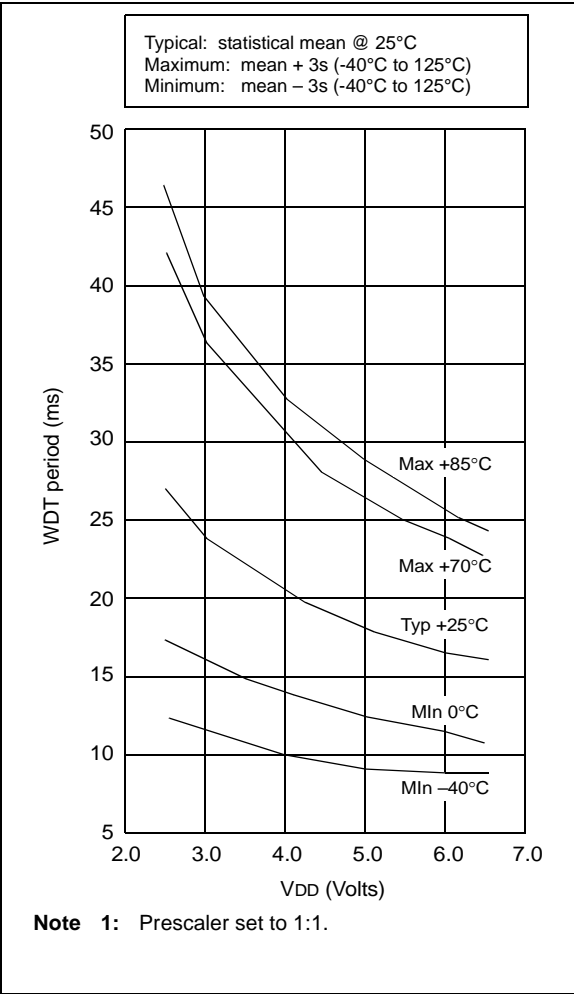
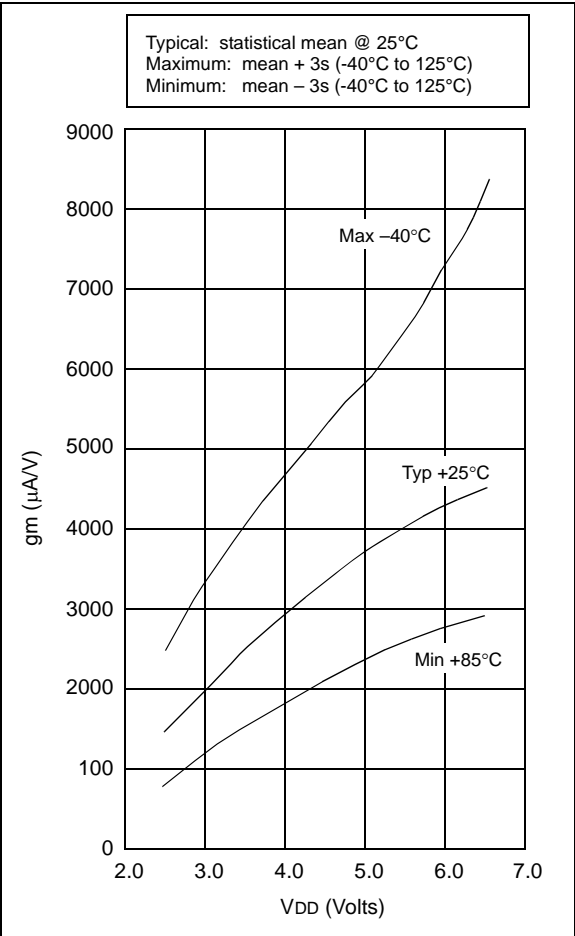


FIGURE 14-16: TRANSCONDUCTANCE (gm) OF HS OSCILLATOR vs. VDD



15.1 DC Characteristics: PIC16C54A-04, 10, 20 (Commercial) PIC16C54A-04I, 10I, 20I (Industrial) PIC16LC54A-04 (Commercial) PIC16LC54A-04I (Industrial)

PIC16LC54A-04 PIC16LC54A-04I (Commercial, Industrial)			Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial				
PIC16C54A-04, 10, 20 PIC16C54A-04I, 10I, 20I (Commercial, Industrial)			Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial				
Param No.	Symbol	Characteristic/Device	Min	Typ†	Max	Units	Conditions
D006	IPD	PIC16LC5X	Power-down Current⁽²⁾				
			—	2.5	12	μA	V _{DD} = 2.5V, WDT enabled, Commercial
			—	0.25	4.0	μA	V _{DD} = 2.5V, WDT disabled, Commercial
			—	2.5	14	μA	V _{DD} = 2.5V, WDT enabled, Industrial
D006A		PIC16C5X	—	0.25	5.0	μA	V _{DD} = 2.5V, WDT disabled, Industrial
			—	4.0	12	μA	V _{DD} = 3.0V, WDT enabled, Commercial
			—	0.25	4.0	μA	V _{DD} = 3.0V, WDT disabled, Commercial
			—	5.0	14	μA	V _{DD} = 3.0V, WDT enabled, Industrial
			—	0.3	5.0	μA	V _{DD} = 3.0V, WDT disabled, Industrial

Legend: Rows with standard voltage device data only are shaded for improved readability.

* These parameters are characterized but not tested.

† Data in "Typ" column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

Note 1: This is the limit to which V_{DD} can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.

a) The test conditions for all I_{DD} measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to V_{SS}, T_{0CKI} = V_{DD}, MCLR = V_{DD}; WDT enabled/disabled as specified.

b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.

3: Does not include current through R_{EXT}. The current through the resistor can be estimated by the formula: I_R = V_{DD}/2R_{EXT} (mA) with R_{EXT} in kΩ.

FIGURE 15-5: TIMER0 CLOCK TIMINGS - PIC16C54A

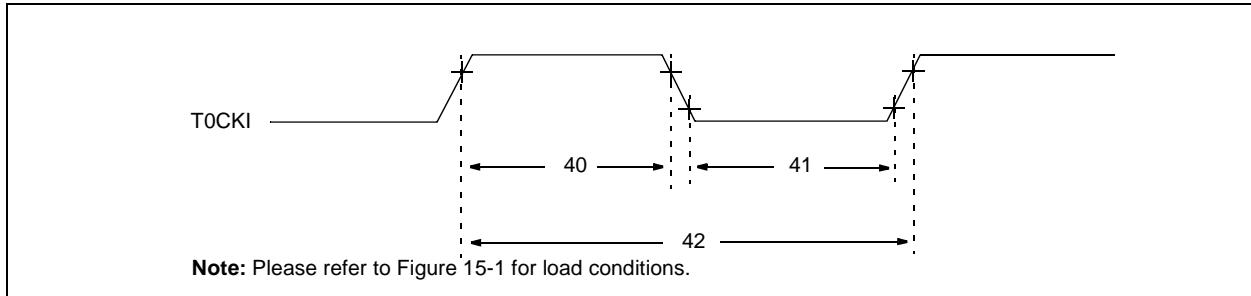


TABLE 15-4: TIMER0 CLOCK REQUIREMENTS - PIC16C54A

Standard Operating Conditions (unless otherwise specified) Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-20^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial - PIC16LV54A-02I $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended							
AC Characteristics							
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width					
		- No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	10^*	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width					
		- No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	10^*	—	—	ns	
42	Tt0P	T0CKI Period	20 or $\frac{T_{CY} + 40^*}{N}$	—	—	ns	Whichever is greater. N = Prescale Value (1, 2, 4,..., 256)

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 16-20: PORTA, B AND C I_{OH} vs. V_{OH}, V_{DD} = 3V

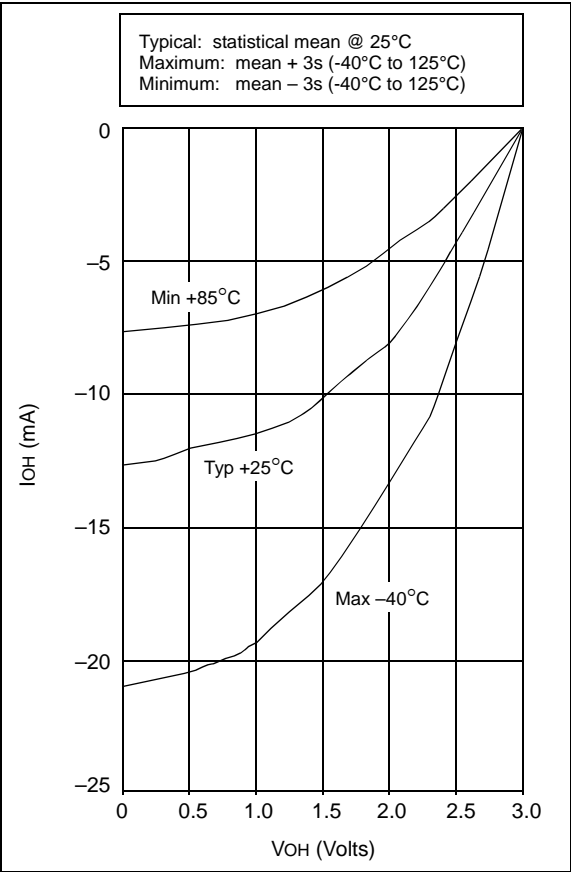
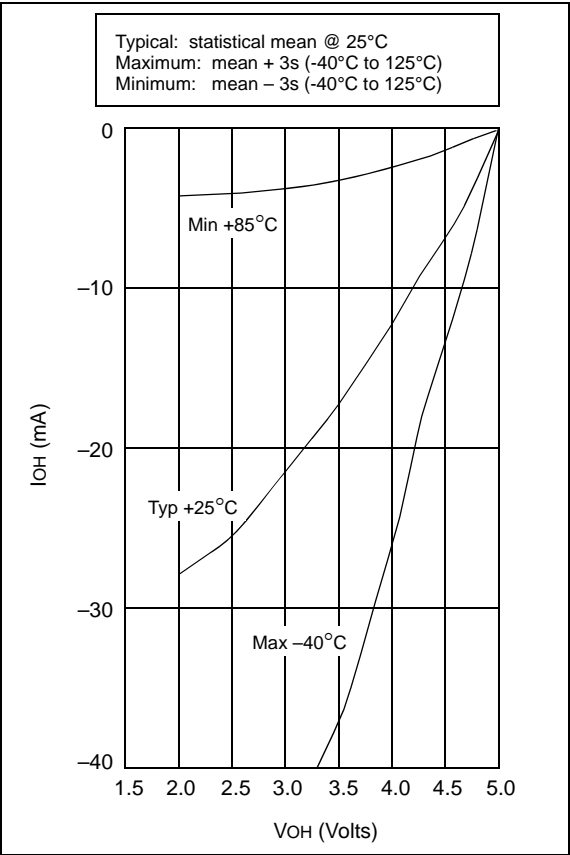


FIGURE 16-21: PORTA, B AND C I_{OH} vs. V_{OH}, V_{DD} = 5V



PIC16C5X

FIGURE 17-1: PIC16C54C/55A/56A/57C/58B-04, 20 VOLTAGE-FREQUENCY GRAPH, $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (COMMERCIAL TEMPS)

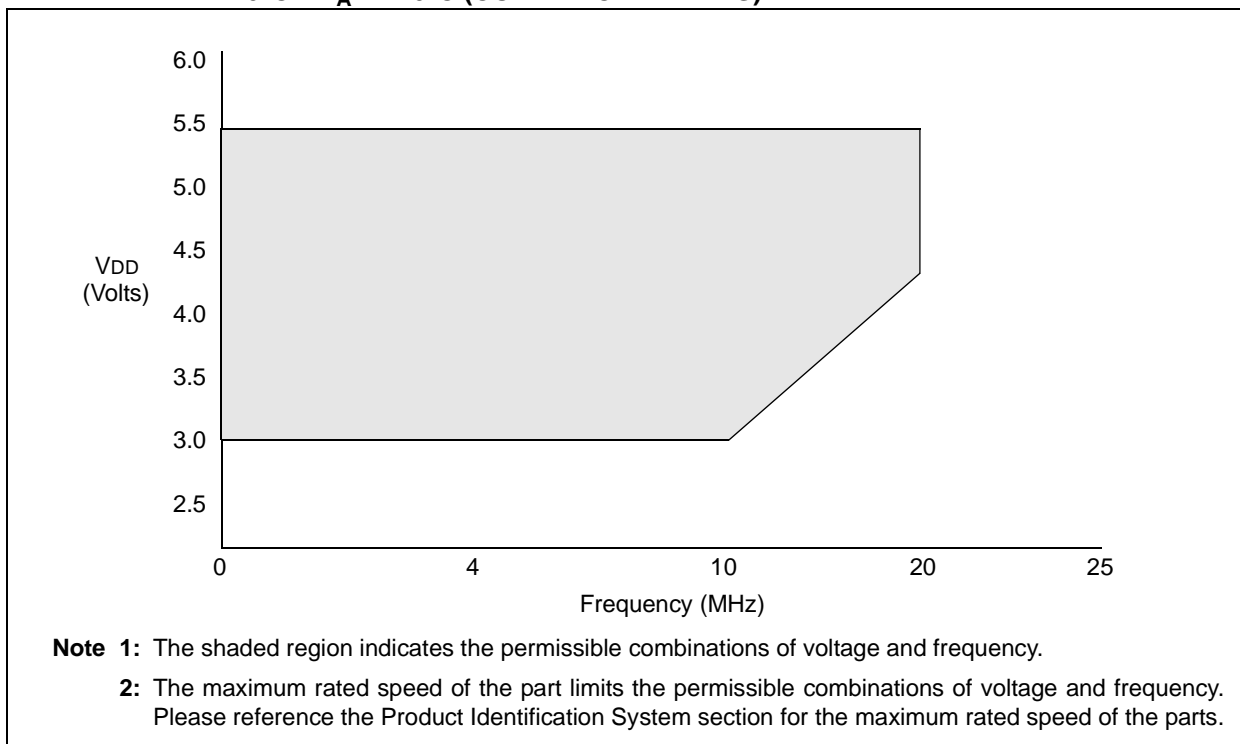


FIGURE 17-2: PIC16C54C/55A/56A/57C/58B-04, 20 VOLTAGE-FREQUENCY GRAPH, $-40^{\circ}\text{C} \leq T_A < 0^{\circ}\text{C}$, $+70^{\circ}\text{C} < T_A \leq +125^{\circ}\text{C}$ (OUTSIDE OF COMMERCIAL TEMPS)

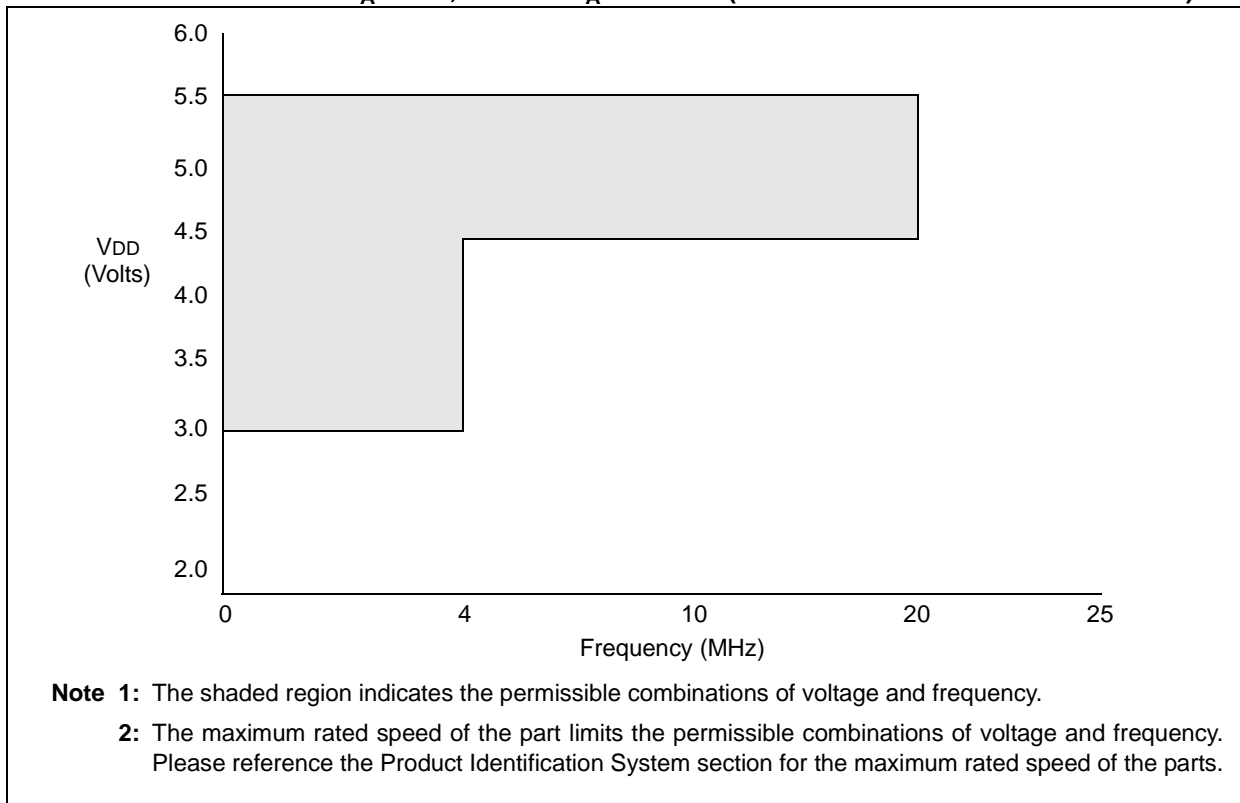


FIGURE 17-8: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER TIMING - PIC16C5X, PIC16CR5X

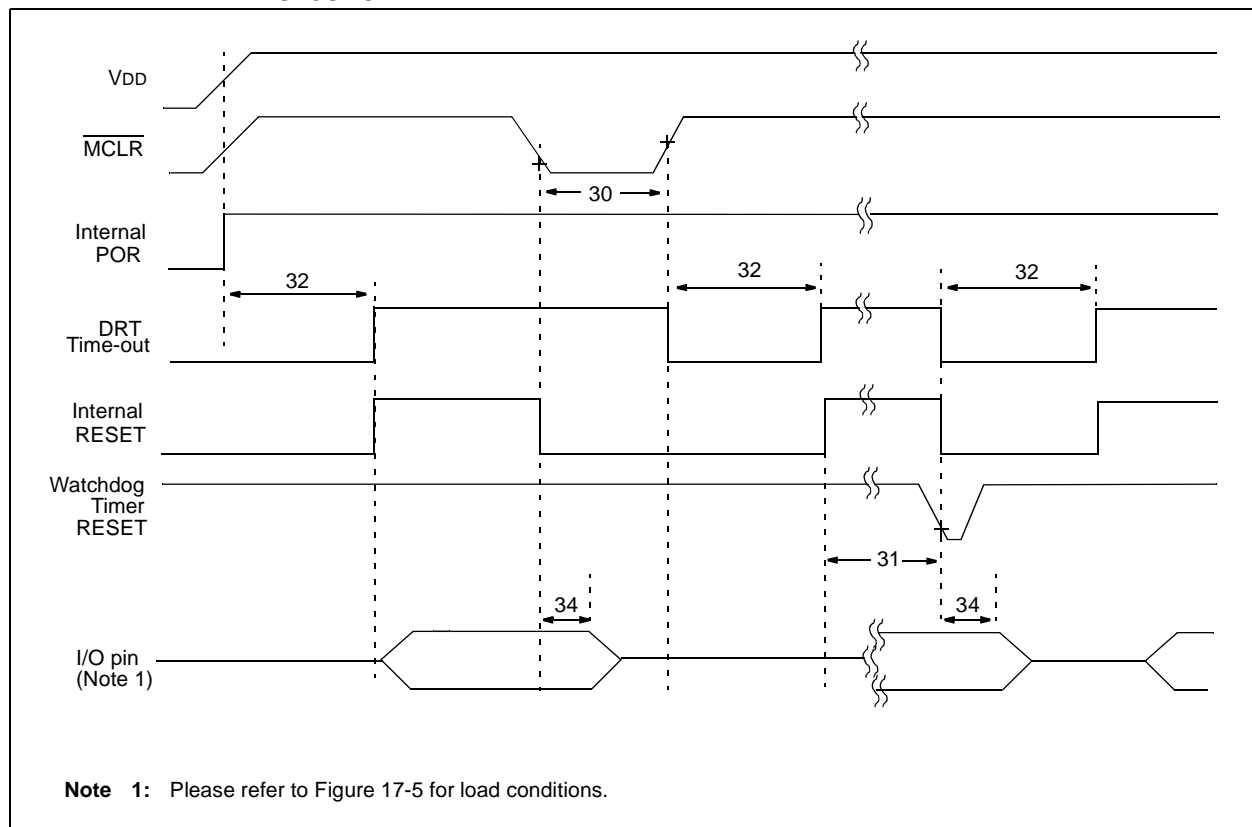


TABLE 17-3: RESET, WATCHDOG TIMER, AND DEVICE RESET TIMER - PIC16C5X, PIC16CR5X

Standard Operating Conditions (unless otherwise specified)							
AC Characteristics		Operating Temperature					
		0°C ≤ TA ≤ +70°C for commercial					
		-40°C ≤ TA ≤ +85°C for industrial					
		-40°C ≤ TA ≤ +125°C for extended					
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
30	Tmcl	MCLR Pulse Width (low)	1000*	—	—	ns	VDD = 5.0V
31	Twdt	Watchdog Timer Time-out Period (No Prescaler)	9.0*	18*	30*	ms	VDD = 5.0V (Comm)
32	TDRT	Device Reset Timer Period	9.0*	18*	30*	ms	VDD = 5.0V (Comm)
34	Tioz	I/O Hi-impedance from MCLR Low	100*	300*	1000*	ns	

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

PIC16C5X

FIGURE 18-10: V_{TH} (INPUT THRESHOLD TRIP POINT VOLTAGE) OF OSC1 INPUT (IN XT, HS AND LP MODES) vs. V_{DD}

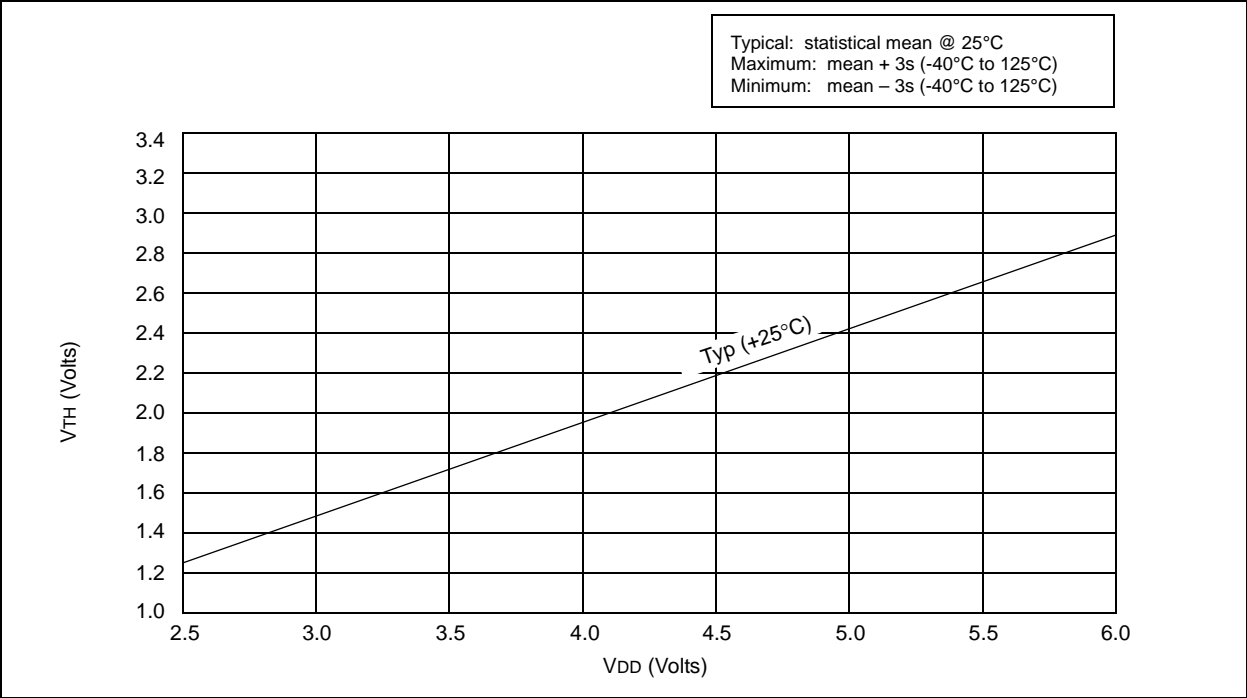
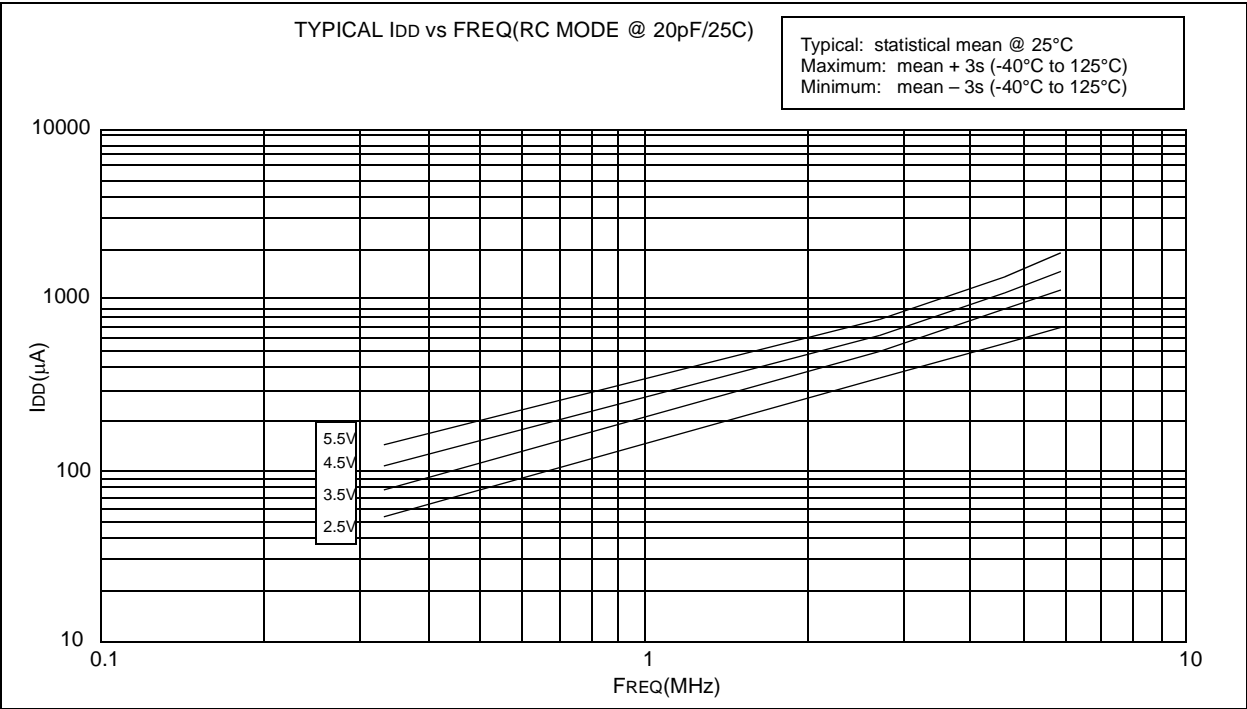


FIGURE 18-11: TYPICAL I_{DD} vs. FREQUENCY (WDT DISABLED, RC MODE @ 20 pF, 25°C)



PIC16C5X

19.4 Timing Diagrams and Specifications

FIGURE 19-3: EXTERNAL CLOCK TIMING - PIC16C5X-40

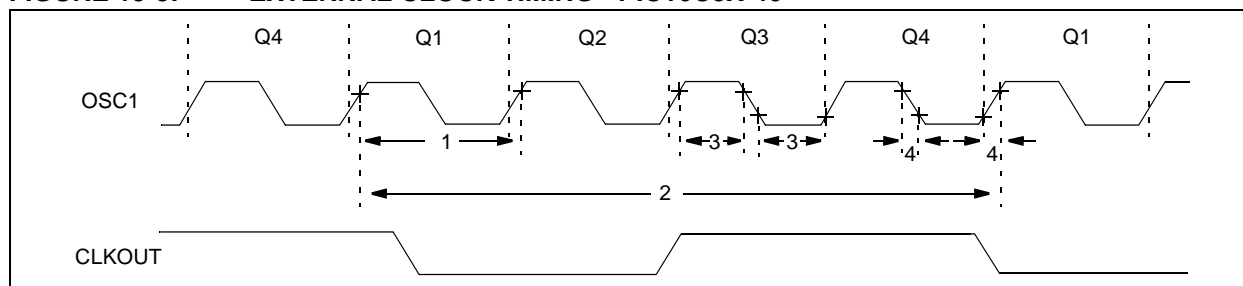


TABLE 19-1: EXTERNAL CLOCK TIMING REQUIREMENTS - PIC16C5X-40

AC Characteristics		Standard Operating Conditions (unless otherwise specified)					
		Operating Temperature 0°C ≤ TA ≤ +70°C for commercial					
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
	FOSC	External CLKIN Frequency ⁽¹⁾	20	—	40	MHz	HS osc mode
1	TOSC	External CLKIN Period ⁽¹⁾	25	—	—	ns	HS osc mode
2	Tcy	Instruction Cycle Time ⁽²⁾	—	4/FOSC	—	—	
3	TosL, TosH	Clock in (OSC1) Low or High Time	6.0*	—	—	ns	HS oscillator
4	TosR, TosF	Clock in (OSC1) Rise or Fall Time	—	—	6.5*	ns	HS oscillator

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption.

When an external clock input is used, the "max" cycle time limit is "DC" (no clock) for all devices.

2: Instruction cycle period (Tcy) equals four times the input oscillator time base period.

FIGURE 19-6: TIMER0 CLOCK TIMINGS - PIC16C5X-40

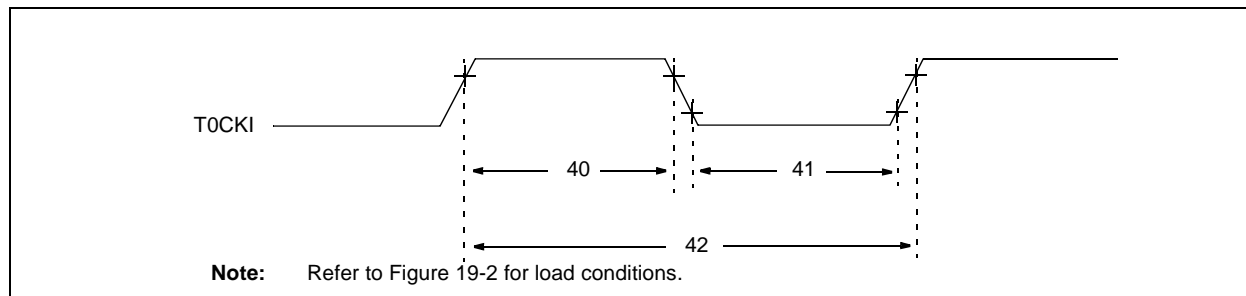


TABLE 19-4: TIMER0 CLOCK REQUIREMENTS PIC16C5X-40

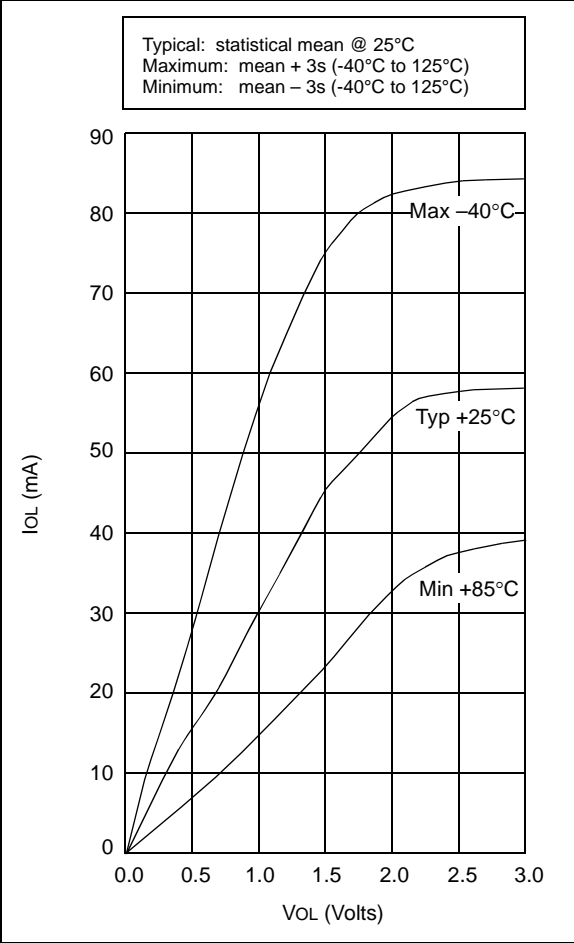
AC Characteristics			Standard Operating Conditions (unless otherwise specified)				
			Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial				
Param No.	Symbol	Characteristic	Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width - No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	10^*	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width - No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
		- With Prescaler	10^*	—	—	ns	
42	Tt0P	T0CKI Period	$20 \text{ or } \frac{T_{CY} + 40^*}{N}$	—	—	ns	Whichever is greater. N = Prescale Value (1, 2, 4,..., 256)

* These parameters are characterized but not tested.

† Data in the Typical ("Typ") column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

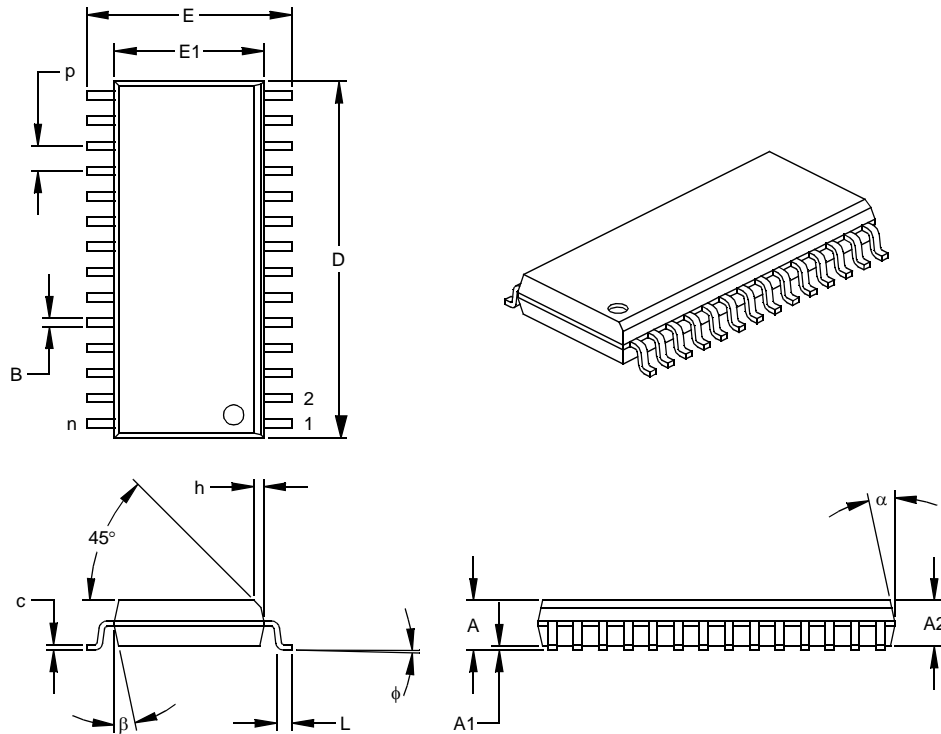
PIC16C5X

FIGURE 20-9: I_{OL} vs. V_{OL} , $V_{DD} = 5\text{ V}$



28-Lead Plastic Small Outline (SO) – Wide, 300 mil (SOIC)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packageing>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		28			28	
Pitch	p		.050			1.27	
Overall Height	A	.093	.099	.104	2.36	2.50	2.64
Molded Package Thickness	A2	.088	.091	.094	2.24	2.31	2.39
Standoff §	A1	.004	.008	.012	0.10	0.20	0.30
Overall Width	E	.394	.407	.420	10.01	10.34	10.67
Molded Package Width	E1	.288	.295	.299	7.32	7.49	7.59
Overall Length	D	.695	.704	.712	17.65	17.87	18.08
Chamfer Distance	h	.010	.020	.029	0.25	0.50	0.74
Foot Length	L	.016	.033	.050	0.41	0.84	1.27
Foot Angle Top	φ	0	4	8	0	4	8
Lead Thickness	c	.009	.011	.013	0.23	0.28	0.33
Lead Width	B	.014	.017	.020	0.36	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

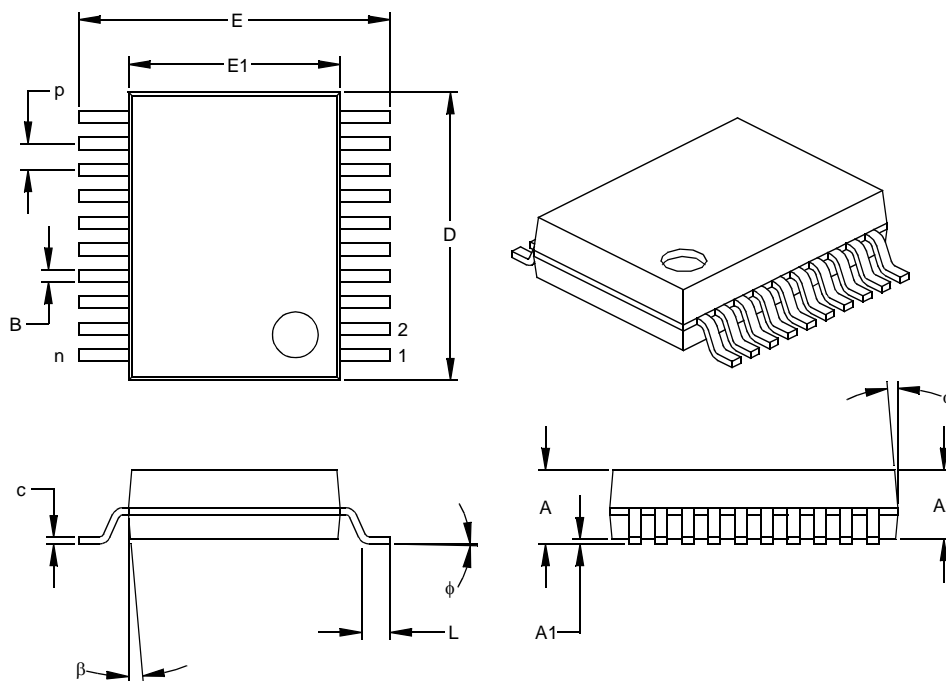
JEDEC Equivalent: MS-013

Drawing No. C04-052

PIC16C5X

20-Lead Plastic Shrink Small Outline (SS) – 209 mil, 5.30 mm (SSOP)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		20			20	
Pitch	p		.026			0.65	
Overall Height	A	.068	.073	.078	1.73	1.85	1.98
Molded Package Thickness	A2	.064	.068	.072	1.63	1.73	1.83
Standoff §	A1	.002	.006	.010	0.05	0.15	0.25
Overall Width	E	.299	.309	.322	7.59	7.85	8.18
Molded Package Width	E1	.201	.207	.212	5.11	5.25	5.38
Overall Length	D	.278	.284	.289	7.06	7.20	7.34
Foot Length	L	.022	.030	.037	0.56	0.75	0.94
Lead Thickness	c	.004	.007	.010	0.10	0.18	0.25
Foot Angle	φ	0	4	8	0.00	101.60	203.20
Lead Width	B	.010	.013	.015	0.25	0.32	0.38
Mold Draft Angle Top	α	0	5	10	0	5	10
Mold Draft Angle Bottom	β	0	5	10	0	5	10

* Controlling Parameter

§ Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MO-150

Drawing No. C04-072

PIC16C5X

M

MCLR Reset	
Register values on	20
Memory Map	
PIC16C54/CR54/C55	25
PIC16C56/CR56	25
PIC16C57/CR57/C58/CR58	25
Memory Organization	25
MOVF	56
MOVLW	56
MOVWF	57
MPLAB C17 and MPLAB C18 C Compilers	61
MPLAB ICD In-Circuit Debugger	63
MPLAB ICE High Performance Universal In-Circuit Emulator with MPLAB IDE	62
MPLAB Integrated Development Environment Software	61
MPLINK Object Linker/MPLIB Object Librarian	62

N

NOP	57
-----------	----

O

One-Time-Programmable (OTP) Devices	7
OPTION	57
OPTION Register	30
Value on reset	20
Oscillator Configurations	15
Oscillator Types	
HS	15
LP	15
RC	15
XT	15

P

PA0 bit	29
PA1 bit	29
Paging	31
PC	31
Value on reset	20
PD bit	19, 29
Peripheral Features	1
PICDEM 1 Low Cost PIC MCU Demonstration Board	63
PICDEM 17 Demonstration Board	64
PICDEM 2 Low Cost PIC16CXX Demonstration Board	63
PICDEM 3 Low Cost PIC16CXXX Demonstration Board	64
PICSTART Plus Entry Level Development Programmer	63
Pin Configurations	2
Pinout Description - PIC16C54, PIC16CR54, PIC16C56, PIC16CR56, PIC16C58, PIC16CR58	11
Pinout Description - PIC16C55, PIC16C57, PIC16CR57 ...	12
PORTA	35
Value on reset	20
PORTB	35
Value on reset	20
PORTC	35
Value on reset	20
Power-Down Mode	47
Power-On Reset (POR)	21
Register values on	20
Prescaler	40
PRO MATE II Universal Device Programmer	63
Program Counter	31
Program Memory Organization	25
Program Verification/Code Protection	47

Q

Q cycles	13
Quick-Turnaround-Production (QTP) Devices	7

R

RC Oscillator	17
Read Only Memory (ROM) Devices	7
Read-Modify-Write	36
Register File Map	
PIC16C54, PIC16CR54, PIC16C55, PIC16C56, PIC16CR56	26
PIC16C57/CR57	27
PIC16C58/CR58	27
Registers	
Special Function	28
Value on reset	20
Reset	19
Reset on Brown-Out	23
RETLW	57
RLF	58
RRF	58

S

Serialized Quick-Turnaround-Production (SQTP) Devices...	7
SLEEP	43, 47, 58
Software Simulator (MPLAB SIM)	62
Special Features of the CPU	43
Special Function Registers	28
Stack	32
STATUS Register	9, 29
Value on reset	20
SUBWF	59
SWAPF	59

T

Timer0	
Switching Prescaler Assignment	40
Timer0 (TMR0) Module	37
TMR0 register - Value on reset	20
TMR0 with External Clock	39
Timing Diagrams and Specifications	
PIC16C54/55/56/57	74
PIC16C54A	111
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/ C58B/CR58B	140
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/ C58B/CR58B-40	160
PIC16CR54A	86
Timing Parameter Symbolology and Load Conditions	
PIC16C54/55/56/57	73
PIC16C54A	110
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/ C58B/CR58B	139
PIC16C54C/CR54C/C55A/C56A/CR56A/C57C/CR57C/ C58B/CR58B-40	159
PIC16CR54A	85
TO bit	19, 29
TRIS	59
TRIS Registers	35
Value on reset	20

U

UV Erasable Devices	7
---------------------------	---